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**IN THE CLAIMS:**

1. (Currently Amended) A manufacturing method of a display device comprising:  
selectively forming a pattern comprising a composition which is emitted by use of  
droplet emitting means; [[and]]

baking the pattern; and

carrying out plasma processing to the baked pattern by use of atmospheric plasma  
processing means,

wherein the droplet emitting means comprises a droplet emitting head in which a  
plurality of droplet emitting holes are disposed in a line form, and

wherein the atmospheric plasma processing means comprises plasma generating  
means under atmospheric pressure or vicinity of atmospheric pressure.

2. (Currently Amended) A manufacturing method of a display device comprising:

selectively forming a wiring by use of droplet emitting means;

selectively forming a resist and a wiring by use of droplet emitting means, over the  
wiring; and

etching the wiring by use of atmospheric plasma;

ashing the resist ~~and etching the wiring~~ by use of atmospheric plasma processing  
means after etching the wiring,

wherein the droplet emitting means comprises a droplet emitting head in which a  
plurality of droplet emitting holes are disposed in a line form, and

wherein the atmospheric plasma processing means comprises plasma generating  
means under atmospheric pressure or vicinity of atmospheric pressure.

3. (Currently Amended) A manufacturing method of a display device comprising:

selectively forming a resist by use of droplet emitting means; and

baking the resist;

etching an electric conductive film which is disposed under the baked resist by use  
of atmospheric plasma processing means;

ashing the baked resist ~~and etching an electric conductive film which is disposed~~  
~~under the resist~~ by use of atmospheric plasma processing means,

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wherein the droplet emitting means comprises a droplet emitting head in which a plurality of droplet emitting holes are disposed in a line form, and

wherein the atmospheric plasma processing means comprises plasma generating means under atmospheric pressure or vicinity of atmospheric pressure.

4. (Currently Amended) A manufacturing method of a display device comprising:  
selectively forming a pattern comprising a composition which is emitted by use of droplet emitting means, and

baking the pattern;

carrying out plasma processing to the baked pattern by use of plasma processing means for carrying out local plasma processing,

wherein the droplet emitting means comprises a droplet emitting head in which one or a plurality of droplet emitting holes are disposed, and

wherein the plasma processing means for carrying out local plasma processing comprises plasma generating means under atmospheric pressure or the vicinity of atmospheric pressure.

5. (Currently Amended) A manufacturing method of a display device comprising:

selectively forming a wiring by use of droplet emitting means;

selectively forming a resist and a wiring by use of droplet emitting means, over the wiring; [[and]]

etching the wiring by use of atmospheric plasma for carrying out local plasma processing; and

ashing the resist and etching the wiring by use of plasma processing means for carrying out local plasma processing, after etching the wiring,

wherein the droplet emitting means comprises a droplet emitting head in which one or a plurality of droplet emitting holes are disposed, and

wherein the plasma processing means for carrying out local plasma processing comprises plasma generating means under atmospheric pressure or the vicinity of atmospheric pressure.

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6. (Currently Amended) A manufacturing method of a display device comprising:  
selectively forming a wiring;  
selectively forming a resist by use of a droplet emitting means, over the wiring; and  
etching the wiring by use of plasma processing means for carrying out local plasma  
processing;

~~ashing the resist and etching a wiring~~ by use of plasma processing means for  
carrying out local plasma processing, after etching the wiring,

wherein the droplet emitting means comprises a droplet emitting head in which one  
or a plurality of droplet emitting holes are disposed, and

wherein the plasma processing means for carrying out local plasma processing  
comprises plasma generating means under atmospheric pressure or the vicinity of  
atmospheric pressure.

7. (Previously Presented) A manufacturing method of a display device according to  
claim 1, wherein the droplet comprises any one of a photosensitive resist, a paste form metal  
material or organic liquid solution which includes the paste form metal, a ultra-fine particle  
form metal material or organic liquid solution which includes the metal material.

8-9. (Canceled)

10. (Currently Amended) A manufacturing method of a display device comprising:  
forming a groove in an insulating film formed on a glass substrate;  
emitting a ~~composition~~ wiring material in the groove, by use of droplet emitting  
means[[: and]] to form a wiring in the groove.

~~forming a pattern comprising the composition along the groove, for use as a wiring,~~  
wherein the droplet emitting means comprises a droplet emitting head in which a  
plurality of droplet emitting holes are disposed in a line form, and  
wherein the droplet emitting head moves along the groove when emitting the wiring  
material.

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11. (Currently Amended) A manufacturing method of a display device comprising:  
forming a groove in an insulating film formed on a glass substrate;  
emitting a ~~composition~~ wiring material in the groove, by use of droplet emitting  
means[[: and]] to form a wiring in the groove;  
~~forming a pattern comprising the composition along the groove, to thereby form a~~  
~~wiring;~~  
wherein the droplet emitting means comprises a droplet emitting head in which one  
or a plurality of droplet emitting holes are disposed in a line form, and  
wherein the droplet emitting head moves along the groove when emitting the wiring  
material.

12-13. (Canceled)

14. (Previously Presented) A manufacturing method of a display device comprising:  
selectively forming an electric conductive film, which becomes a wiring, on a  
substrate, by emitting a composition by use of droplet emitting means,  
forming a resist pattern by emitting a resist on the electric conductive film by use of  
the droplet emitting means,  
etching the electric conductive film with the resist pattern as a mask, by use of plasma  
processing means, and  
ashing the resist pattern by use of the plasma processing means, to form a wiring,  
wherein the droplet emitting means comprises a droplet emitting head in which a  
plurality of droplet emitting holes are disposed in a line form, and  
wherein the plasma processing means comprises plasma generating means under  
atmospheric pressure or the vicinity of atmospheric pressure.

15. (Previously Presented) A manufacturing method of a display device comprising:  
selectively forming an electric conductive film, which becomes a wiring, on a  
substrate, by emitting a composition by use of droplet emitting means,  
forming a resist pattern by emitting a resist on the electric conductive film by use of  
the droplet emitting means,

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etching the electric conductive film with the resist pattern as a mask, by use of plasma processing means, and

ashing the resist pattern by use of the plasma processing means, to form a wiring, wherein the droplet emitting means comprises a droplet emitting head in which one or a plurality of droplet emitting holes are disposed in a line form, and

wherein the plasma processing means comprises plasma generating means under atmospheric pressure or the vicinity of atmospheric pressure for carrying out local plasma processing.

16. (Previously Presented) A manufacturing method of a display device according to claim 1, wherein the droplet comprises any one of a photosensitive resist, a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

17. (Previously Presented) A manufacturing method of a display device according to claim 2, wherein the droplet for the resist comprises a photosensitive resist, and the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

18. (Previously Presented) A manufacturing method of a display device according to claim 3, wherein the droplet for the resist comprises a photosensitive resist.

19. (Previously Presented) A manufacturing method of a display device according to claim 4, wherein the droplet comprises any one of a photosensitive resist, a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

20. (Previously Presented) A manufacturing method of a display device according to claim 5, wherein the droplet for the resist comprises a photosensitive resist, and the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution

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which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

21. (Previously Presented) A manufacturing method of a display device according to claim 6, wherein the droplet for the resist comprises a photosensitive resist.

22. (Canceled)

23. (Previously Presented) A manufacturing method of a display device according to claim 10, wherein the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

24. (Previously Presented) A manufacturing method of a display device according to claim 11, wherein the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

25-26. (Canceled)

27. (Previously Presented) A manufacturing method of a display device according to claim 14, wherein the droplet for the resist pattern comprises a photosensitive resist, and the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

28. (Previously Presented) A manufacturing method of a display device according to claim 15, wherein the droplet for the resist pattern comprises a photosensitive resist, and the droplet for the wiring comprises any one of a paste form metal material or organic liquid solution which includes the paste form metal, a ultra-fine particle form metal material or organic liquid solution which includes the metal material.

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